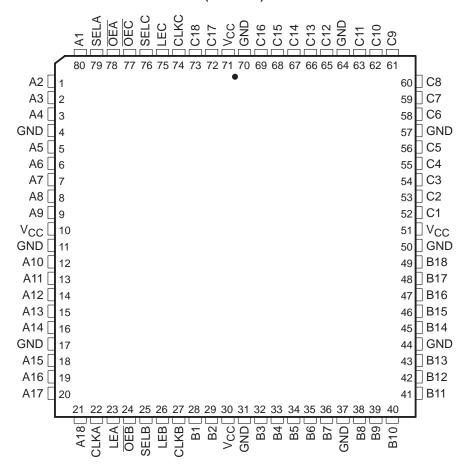
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- Members of the Texas Instruments Widebus+™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- UBE™ (Universal Bus Exchanger)
 Combines D-Type Latches and D-Type
 Flip-Flops for Operation in Transparent,
 Latched, or Clocked Mode
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17

- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 5 V, T_A = 25°C
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OI})
- Bus Hold Inputs Eliminate the Need for External Pullup/Pulldown Resistors
- Packaged in 80-Pin Plastic Thin Quad Flat (PN) Package With 12 × 12-mm Body Using 0.5-mm Lead Pitch

SN74ABT32318 . . . PN PACKAGE (TOP VIEW)



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SN54ABT32318, SN74ABT32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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description

The 'ABT32318 consists of three 18-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable (\overline{OEA} , \overline{OEB} , and \overline{OEC}), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA is low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABT32318 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT32318 is characterized for operation from –40°C to 85°C.

Function Tables

STORAGE†

ı	INPUTS				
CLKA	LEA	Α	OUTPUT		
1	L	L	L		
1	L	Н	Н		
Н	L	Χ	Q ₀ ‡		
L	L	Χ	Q ₀ ‡ Q ₀ ‡		
Х	Н	L	L		
Х	Н	Н	Н		

[†]A-port register shown. B and C ports are similar but use CLKB, CLKC, LEB, and

A-PORT OUTPUT

INF	PUTS	OUTDUT A		
OEA	SELA	OUTPUT A		
Н	Х	Z		
L	Н	Output of C register		
L	L	Output of B register		

B-PORT OUTPUT

INP	UTS	OUTPUT D
OEB	SELB	OUTPUT B
Н	Х	Z
L	Н	Output of A register
L	L	Output of C register

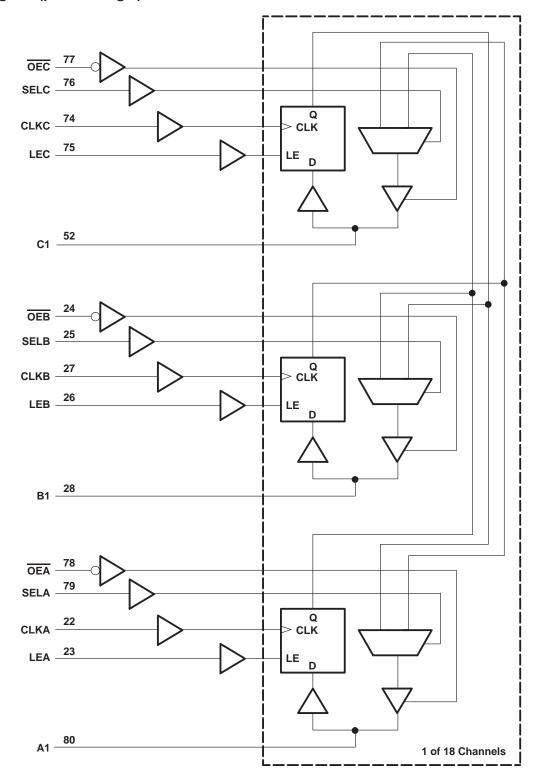
C-PORT OUTPUT

INP	UTS	OUTDUT O
OEC	SELC	OUTPUT C
Н	Χ	Z
L	Н	Output of B register
L	L	Output of A register

[‡]Output level before the indicated steady-state input conditions were established.

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V _O	-0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT32318	96 mA
SN74ABT32318	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Maximum power dissipation at T _A = 55°C (in still air) (see Note 2)	1.1 W
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 3)

			SN54AE	3T32318	SN74AE	3T32318	
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2	, S	2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	Vcc	0	VCC	V
IOH	High-level output current		É	-24		-32	mA
l _{OL}	Low-level output current		172	48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled	30%	10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused or floating control pins must be held high or low.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 75 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ABT32318			SN74ABT32318				
				MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNIT	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5				
V		$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3			3			V	
VOH		V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$	2						V	
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$				2				
\/-·		V 45V	$I_{OL} = 48 \text{ mA}$			0.55			0.55	V	
VOL		V _{CC} = 4.5 V	I _{OL} = 64 mA			0.55			0.55	V	
	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±1			±1		
lį	A, B, or C ports	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±20			±20	μА	
	A, B, or C	V 45V	V _I = 0.8 V	100	Ü	Z'	100			•	
l(hold)	ports	V _{CC} = 4.5 V	V _I = 2 V	-100	N.		-100			μΑ	
lozpu‡		$\frac{\text{V}_{CC}}{\text{OE}} = 0 \text{ to } 2.1 \text{ V},$	$V_0 = 0.5 \text{ V to } 2.7 \text{ V},$		J. D.	±50			±50	μΑ	
lozpd‡		$\frac{V_{CC}}{OE} = 2.1 \text{ V to } 0,$	$V_0 = 0.5 \text{ V to } 2.7 \text{ V},$	0	5	±50			±50	μΑ	
IOZH§		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$	$V_O = 2.7 \text{ V}, \overline{OE} \ge 2 \text{ V}$	Q		10			10	μΑ	
I _{OZL} §		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$	$V_O = 0.5 \text{ V}, \overline{OE} \ge 2 \text{ V}$			-10			-10	μΑ	
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100			±100	μΑ	
ICEX		V _{CC} = 5.5 V,	V _O = 5.5 V Outputs high			50			50	μΑ	
IOI		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-100	-180	mA	
		V _{CC} = 5.5 V,	Outputs high			2			2		
ICC		$I_{O} = 0$,	Outputs low			45			45	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			1			1		
ΔI _{CC} #		V _{CC} = 5.5 V, Other inputs at V _{CC} or	One input at 3.4 V,			0.5			0.5	mA	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3			3		pF	
C _{io}	A, B, or C ports	V _O = 2.5 V or 0.5 V			11.5			11.5		pF	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. ‡ This parameter is specified by characterization.

[§] The parameters I_{OZH} and I_{OZL} include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[#]This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

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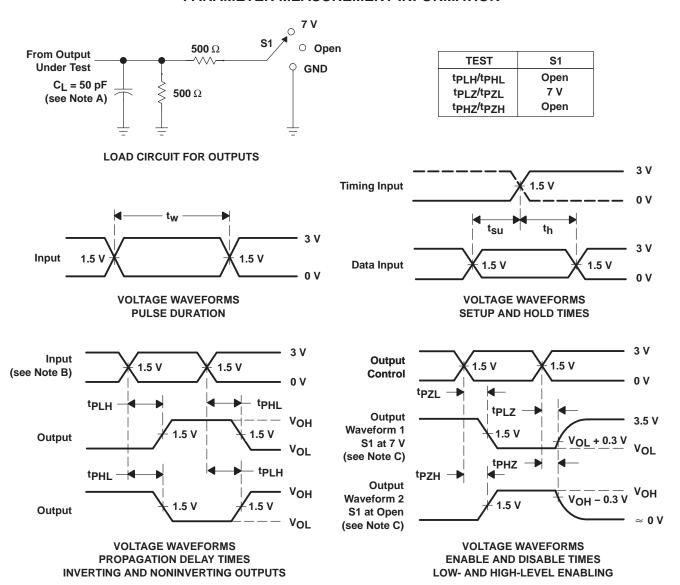
timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN54AI	3T32318	SN74AE	3T32318	
			MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency			150		150	MHz
	Poles deserve	LE high	3.3	Z	3.3		
t _w	Pulse duration	CLK high or low	3.3	BA	3.3		ns
	Ontario Cara	A, B, or C before CLK↑	2.4	7	2.4		
tsu	Setup time	A, B, or C before LE↓	2.1)	2.1		ns
4.	Hold time	A, B, or C after CLK↑	1.4		1.4		
^t h	Hold time	A, B, or C after LE↓	2.1		2.1		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

24244555	FROM	ТО	SN54ABT32318	SN74ABT3	
PARAMETER	(INPUT)	(OUTPUT)	MIN MAX	MIN M	AX UNIT
fmax			150	150	MHz
^t PLH	A. D. or C	C B or A	1.4 6.5	1.4	6.1
^t PHL	A, B, or C	C, B, or A	1.1 6.8	1.1	6.6 ns
^t PLH	CEI	C D or A	1.4 6.7	1.4	6.5
^t PHL	SEL	C, B, or A	1.8 6.8	1.8	6.5
^t PLH	LE	0.04	2.6 8	2.6	7.5
t _{PHL}	LE	C, B, or A	2.6 7.4	2.6	6.9 ns
^t PLH	OLIV	C B a A	2.5 8	2.5	7.4
t _{PHL}	CLK	C, B, or A	2.5 7.2	2.5	6.7 ns
^t PZH	ŌĒ	C D A	1.4 6.9	1.4	6.8
^t PZL	UE	C, B, or A	2.4 7.2	2.4	7.1 ns
^t PHZ	ŌĒ	C, B, or A	1 6.4	1	6.2
^t PLZ	UE	C, B, Ol A	2 6.4	2	6 ns

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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